
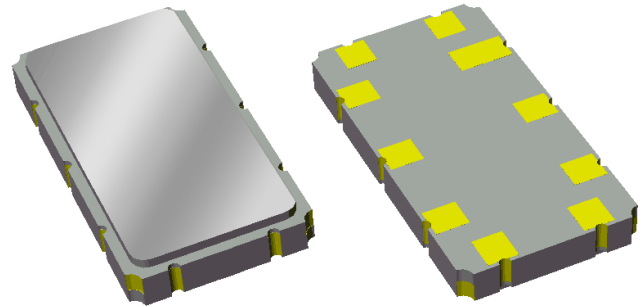


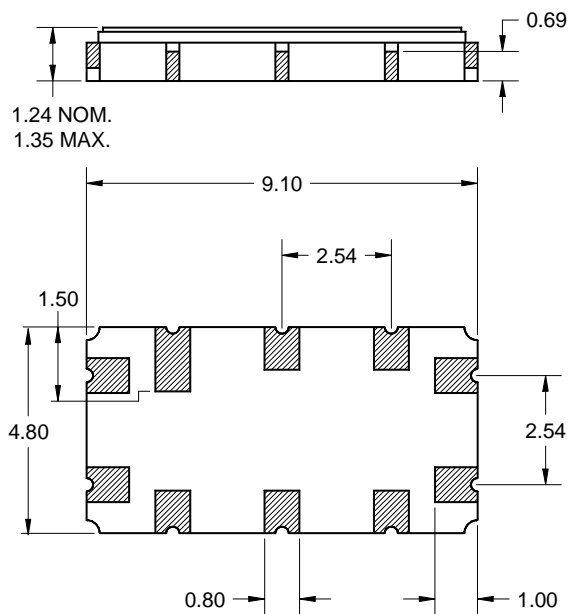
Features

- For GSM/EDGE applications
- Usable bandwidth 400 KHz
- Low loss
- Single-ended and differential operation
- Ceramic Surface Mount Package (SMP)
- Hermetic
- RoHS compliant (2002/95/EC), Pb-free 



Package

Surface Mount 9.10 x 4.80 x 1.24 mm
SMP-35C

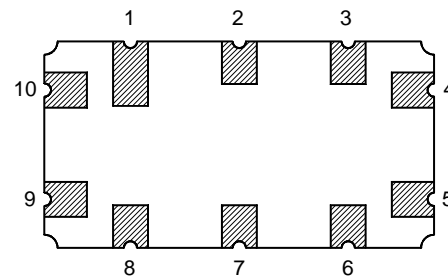


Dimensions shown are nominal in millimeters
All tolerances are $\pm 0.15\text{mm}$ except overall
length and width $+0.10\text{mm}/-0.10\text{mm}$

Body: Al_2O_3 ceramic
Lid: Kovar, Ni plated
Terminations: Au plating 0.5 - 1.0 μm ,
over a 2 - 6 μm Ni plating

Pin Configuration

Bottom View



Pin No.	Description
10	Input
9	Input Return
5	Output
4	Output Return
1,2,3,6,7,8	Case Ground

Electrical Specifications ⁽¹⁾

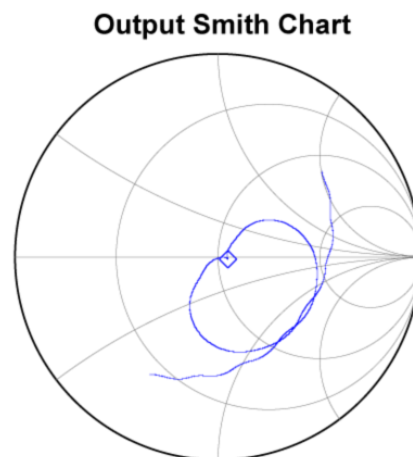
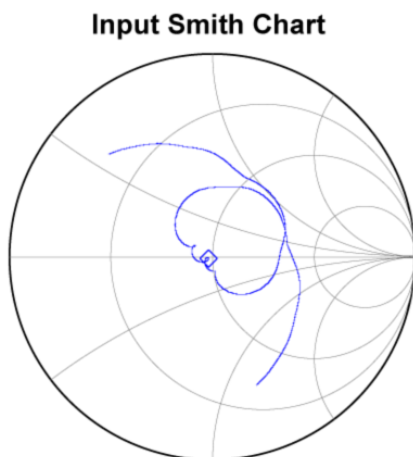
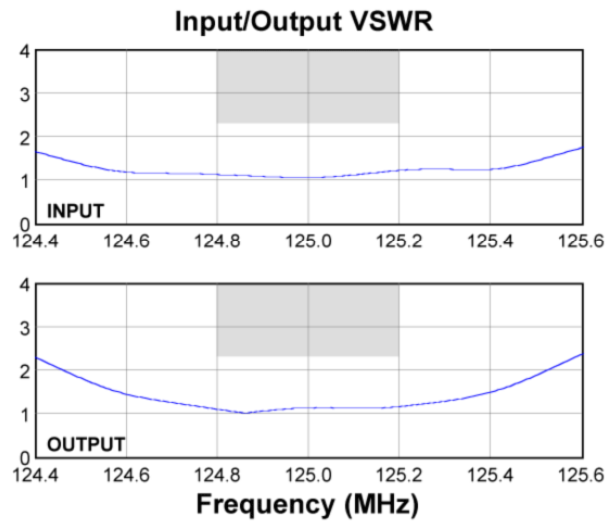
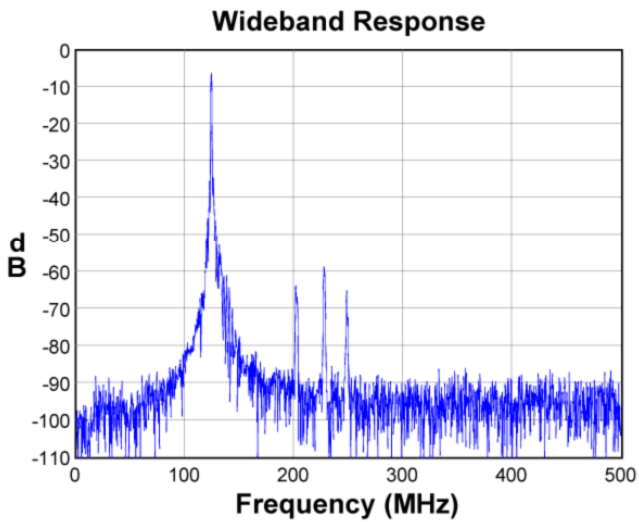
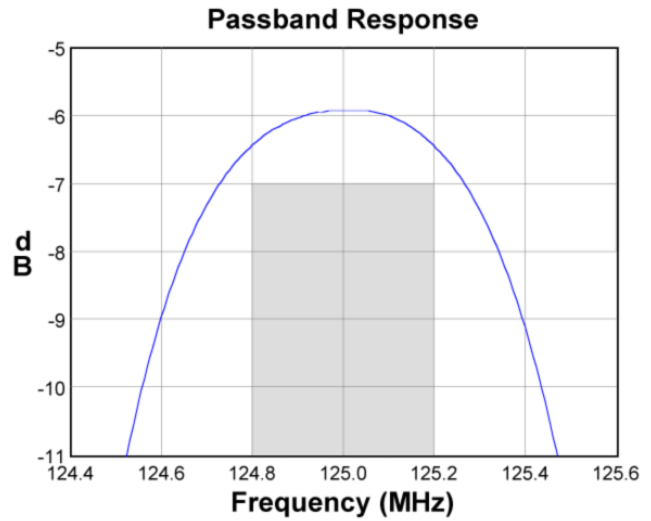
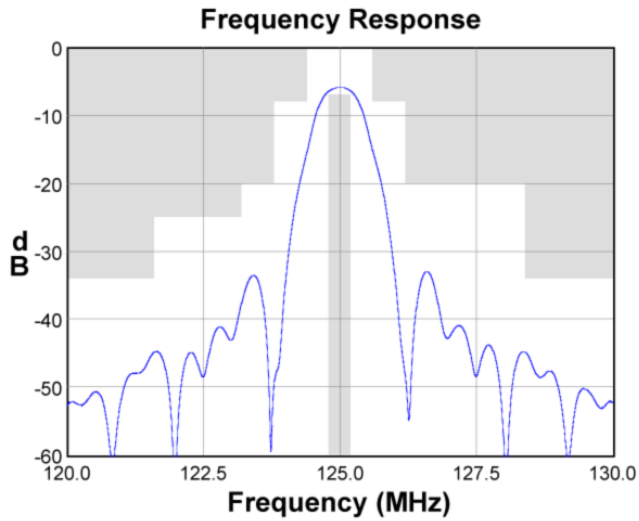
Operating Temperature Range: ⁽²⁾ -10 to +85 °C

Parameter ⁽³⁾	Minimum	Typical ⁽⁴⁾	Maximum	Unit
Center Frequency	-	125	-	MHz
Insertion Loss at Fo	4	5.9	7	dB
1 dB Lower Frequency	-	124.73	124.8	MHz
1 dB Upper Frequency	125.2	125.26	-	MHz
8 dB Lower Frequency	124.4	124.43	-	MHz
8 dB Upper Frequency	-	125.55	125.6	MHz
20 dB Lower Frequency	123.8	124.12	-	MHz
20 dB Upper Frequency	-	125.88	126.2	MHz
Amplitude Variation 124.8 - 125.2 MHz	-	0.55	1.0	dB p-p
Passband Ripple	-	0.01	0.2	dB
Group Delay Variation 124.8 - 125.2 MHz 124.9 - 125.1 MHz	- -	68 37	300 100	nsec nsec
Absolute Delay 124.8 - 125.2 MHz	0.7	0.93	1.7	µsec
Absolute Attenuation 10.0 - 112.0 MHz 112.0 - 115.5 MHz 115.5 - 119.0 MHz 119.0 - 121.6 MHz 121.6 - 123.2 MHz 123.2 - 123.8 MHz 126.2 - 126.8 MHz 126.8 - 128.4 MHz 128.4 - 131.0 MHz 131.0 - 134.5 MHz 134.5 - 138.0 MHz 138.0 - 450.0 MHz	55 43 40 34 25 20 20 25 34 40 43 55	70 65 59 45 37 33 33 37 45 59 68 58	- - - - - - - - - - - -	dB dB dB dB dB dB dB dB dB dB dB dB
Input/Output VSWR 124.8 - 125.2 MHz	-	1.3	2.3	-
Source Impedance ⁽⁵⁾	-	50	-	Ω
Load Impedance ⁽⁵⁾	-	50	-	Ω

Notes:

1. All specifications are based on the test circuit shown on page 4
2. In production, devices will be tested at room temperature to a guardbanded specification to ensure electrical compliance over temperature
3. Electrical margin has been built into the design to account for the variations due to temperature drift and manufacturing tolerances
4. Typical values are based on average measurements at room temperature
5. This is the optimum impedance in order to achieve the performance shown

Typical Performance (at room temperature)



Maximum Ratings

Parameter	Symbol	Minimum	Maximum	Unit
Operating Temperature Range	T	-10	+85	°C
Storage Temperature Range	T _{stg}	-40	+125	°C
Input Power	P _{in}	-	10	dBm

Important Notes

Warnings

- Electrostatic Sensitive Device (ESD)
- Avoid ultrasonic exposure



RoHS Compliance

- This product complies with EU directive 2002/95/EC (RoHS)



Solderability

- Compatible with JESD22-B102, Pb-free process, 260C peak reflow temperature ([see soldering profile](#))

Links to Additional Technical Information

[PCB Layout Tips](#)

[Qualification Flowchart](#)

[Soldering Profile](#)

[S-Parameters](#)

[RoHS Information](#)

[Other Technical Information](#)

TriQuint's liability is limited only to the Surface Acoustic Wave (SAW) component(s) described in this data sheet. TriQuint does not accept any liability for applications, processes, circuits or assemblies, which are implemented using any TriQuint component described in this data sheet.

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